AMENDMENT UNDER 37 C.F.R. § 1.312(a) Serial Number: 09/800,703

Filing Date: March 7, 2001

Title: CHIP PACKAGE WITH DEGASSING HOLES

Assignee: Intel Corporation

Dkt: 884.159US2 (INTEL)

IN THE SPECIFICATION

Please amend the specification as follows:

Please amend the paragraph beginning at page 1, directly after the title, as follows:

This application is a Continuation of U.S. Application No. 09/388,768, filed September 2, 1999, now issued as U.S. Patent 6,225,687.